

# NTHL065N65S3HF

## MOSFET – Power, N-Channel, SUPERFET III, FRFET

**650 V, 46 A, 65 mΩ**

### Description

SUPERFET III MOSFET is ON Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This advanced technology is tailored to minimize conduction loss, provide superior switching performance, and withstand extreme dv/dt rate.

Consequently, SUPERFET III MOSFET is very suitable for the various power system for miniaturization and higher efficiency.

SUPERFET III FRFET MOSFET's optimized reverse recovery performance of body diode can remove additional component and improve system reliability.

### Features

- 700 V @  $T_J = 150^\circ\text{C}$
- Typ.  $R_{DS(on)} = 54 \text{ m}\Omega$
- Ultra Low Gate Charge (Typ.  $Q_g = 98 \text{ nC}$ )
- Low Effective Output Capacitance (Typ.  $C_{oss(\text{eff.})} = 876 \text{ pF}$ )
- 100% Avalanche Tested
- This Device is Pb-Free and is RoHS Compliant

### Applications

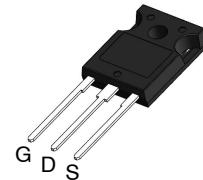
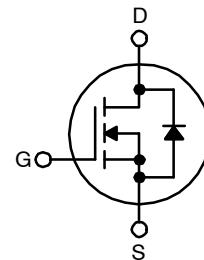
- Telecom / Server Power Supplies
- Industrial Power Supplies
- EV Charger
- USP / Solar

ON

**ON Semiconductor®**

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$V_{DSS}$	$R_{DS(on)\text{ MAX}}$	$I_D \text{ MAX}$
650 V	65 mΩ @ 10 V	46 A



### MARKING DIAGRAM



- \$Y = ON Semiconductor Logo  
&Z = Assembly Plant Code  
&3 = Numeric Date Code  
&K = Lot Code  
NTHL065N65S3HF = Specific Device Code

### ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

# NTHL065N65S3HF

## ABSOLUTE MAXIMUM RATINGS ( $T_C = 25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter		Value	Unit
$V_{DSS}$	Drain to Source Voltage		650	V
$V_{GSS}$	Gate to Source Voltage	DC	$\pm 30$	V
		AC ( $f > 1 \text{ Hz}$ )	$\pm 30$	
$I_D$	Drain Current	Continuous ( $T_C = 25^\circ\text{C}$ )	46	A
		Continuous ( $T_C = 100^\circ\text{C}$ )	30	
$I_{DM}$	Drain Current	Pulsed (Note 1)	115	A
$E_{AS}$	Single Pulsed Avalanche Energy (Note 2)		635	mJ
$I_{AS}$	Avalanche Current (Note 2)		5.3	A
$E_{AR}$	Repetitive Avalanche Energy (Note 1)		3.37	mJ
$dv/dt$	MOSFET $dv/dt$		100	V/ns
	Peak Diode Recovery $dv/dt$ (Note 3)		50	
$P_D$	Power Dissipation	$T_C = 25^\circ\text{C}$	337	W
		Derate Above $25^\circ\text{C}$	2.7	$\text{W}/^\circ\text{C}$
$T_J, T_{STG}$	Operating and Storage Temperature Range		-55 to +150	$^\circ\text{C}$
$T_L$	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds		300	$^\circ\text{C}$

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Repetitive rating: pulse-width limited by maximum junction temperature.
2.  $I_{AS} = 5.3 \text{ A}$ ,  $R_G = 25 \Omega$ , starting  $T_J = 25^\circ\text{C}$ .
3.  $I_{SD} \leq 23 \text{ A}$ ,  $di/dt \leq 200 \text{ A}/\mu\text{s}$ ,  $V_{DD} \leq 400 \text{ V}$ , starting  $T_J = 25^\circ\text{C}$ .

## THERMAL CHARACTERISTICS

Symbol	Parameter	Value	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	0.37	$^\circ\text{C}/\text{W}$
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient, Max.	40	$^\circ\text{C}/\text{W}$

## PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
NTHL065N65S3HF	NTHL065N65S3HF	TO-247	Tube	N/A	N/A	30 Units

# NTHL065N65S3HF

**ELECTRICAL CHARACTERISTICS** ( $T_C = 25^\circ\text{C}$  unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
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## OFF CHARACTERISTICS

$\text{BV}_{\text{DSS}}$	Drain to Source Breakdown Voltage	$V_{\text{GS}} = 0 \text{ V}, I_D = 1 \text{ mA}, T_J = 25^\circ\text{C}$	650	-	-	V
		$V_{\text{GS}} = 0 \text{ V}, I_D = 1 \text{ mA}, T_J = 150^\circ\text{C}$	700	-	-	V
$\Delta V_{\text{DSS}} / \Delta T_J$	Breakdown Voltage Temperature Coefficient	$I_D = 15 \text{ mA}$ , Referenced to $25^\circ\text{C}$	-	0.63	-	$^\circ\text{C}$
$I_{\text{DS}}^{\text{SS}}$	Zero Gate Voltage Drain Current	$V_{\text{DS}} = 650 \text{ V}, V_{\text{GS}} = 0 \text{ V}$	-	-	10	$\mu\text{A}$
		$V_{\text{DS}} = 520 \text{ V}, T_C = 125^\circ\text{C}$	-	153	-	
$I_{\text{GSS}}$	Gate to Body Leakage Current	$V_{\text{GS}} = \pm 30 \text{ V}, V_{\text{DS}} = 0 \text{ V}$	-	-	$\pm 100$	nA

## ON CHARACTERISTICS

$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{GS}} = V_{\text{DS}}, I_D = 1.3 \text{ mA}$	3.0	-	5.0	V
$R_{\text{DS(on)}}$	Static Drain to Source On Resistance	$V_{\text{GS}} = 10 \text{ V}, I_D = 23 \text{ A}$	-	54	65	$\text{m}\Omega$
$g_{\text{FS}}$	Forward Transconductance	$V_{\text{DS}} = 20 \text{ V}, I_D = 23 \text{ A}$	-	31	-	S

## DYNAMIC CHARACTERISTICS

$C_{\text{iss}}$	Input Capacitance	$V_{\text{DS}} = 400 \text{ V}, V_{\text{GS}} = 0 \text{ V}, f = 1 \text{ MHz}$	-	4075	-	pF
$C_{\text{ooss}}$	Output Capacitance		-	95	-	pF
$C_{\text{ooss(eff.)}}$	Effective Output Capacitance	$V_{\text{DS}} = 0 \text{ V to } 400 \text{ V}, V_{\text{GS}} = 0 \text{ V}$	-	876	-	pF
$C_{\text{ooss(er.)}}$	Energy Related Output Capacitance	$V_{\text{DS}} = 0 \text{ V to } 400 \text{ V}, V_{\text{GS}} = 0 \text{ V}$	-	160	-	pF
$Q_{\text{g(tot)}}$	Total Gate Charge at 10V	$V_{\text{DS}} = 400 \text{ V}, I_D = 23 \text{ A}, V_{\text{GS}} = 10 \text{ V}$ (Note 4)	-	98	-	nC
$Q_{\text{gs}}$	Gate to Source Gate Charge		-	30	-	nC
$Q_{\text{gd}}$	Gate to Drain "Miller" Charge		-	38	-	nC
$ESR$	Equivalent Series Resistance	$f = 1 \text{ MHz}$	-	1.5	-	$\Omega$

## SWITCHING CHARACTERISTICS

$t_{\text{d(on)}}$	Turn-On Delay Time	$V_{\text{DD}} = 400 \text{ V}, I_D = 23 \text{ A}, V_{\text{GS}} = 10 \text{ V}, R_g = 2.7 \Omega$ (Note 4)	-	33	-	ns
$t_r$	Turn-On Rise Time		-	24	-	ns
$t_{\text{d(off)}}$	Turn-Off Delay Time		-	79	-	ns
$t_f$	Turn-Off Fall Time		-	14	-	ns

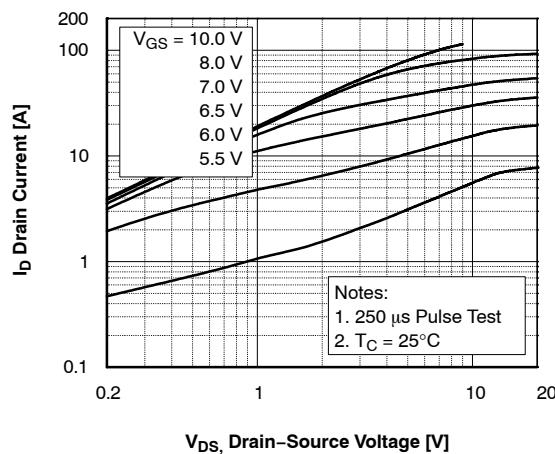
## SOURCE-DRAIN DIODE CHARACTERISTICS

$I_S$	Maximum Continuous Source to Drain Diode Forward Current	-	-	46	A	
$I_{\text{SM}}$	Maximum Pulsed Source to Drain Diode Forward Current	-	-	115	A	
$V_{\text{SD}}$	Source to Drain Diode Forward Voltage	$V_{\text{GS}} = 0 \text{ V}, I_{\text{SD}} = 23 \text{ A}$	-	-	1.3	V
$t_{\text{rr}}$	Reverse Recovery Time	$V_{\text{DD}} = 400 \text{ V}, I_{\text{SD}} = 23 \text{ A}, dI_F/dt = 100 \text{ A}/\mu\text{s}$	-	116	-	ns
$Q_{\text{rr}}$	Reverse Recovery Charge		-	488	-	nC

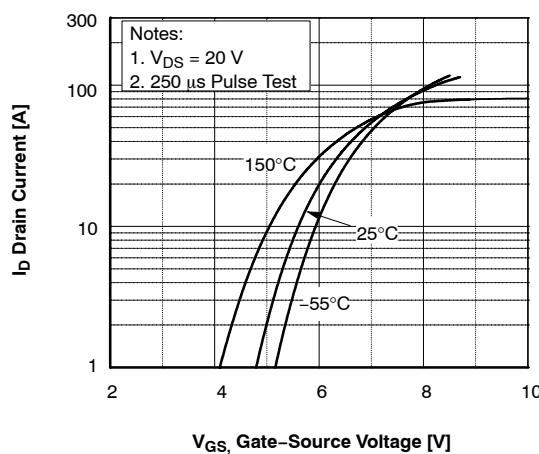
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

4. Essentially independent of operating temperature typical characteristics.

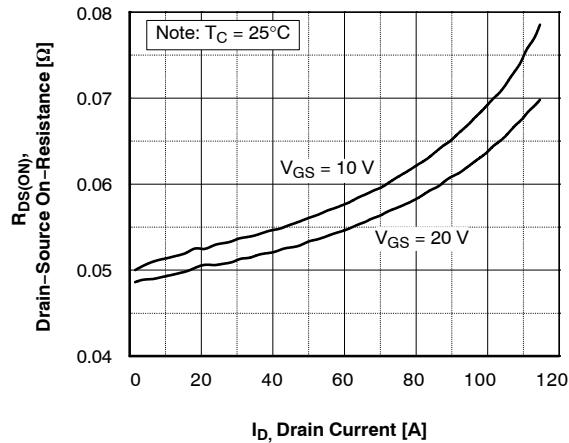
## TYPICAL PERFORMANCE CHARACTERISTICS



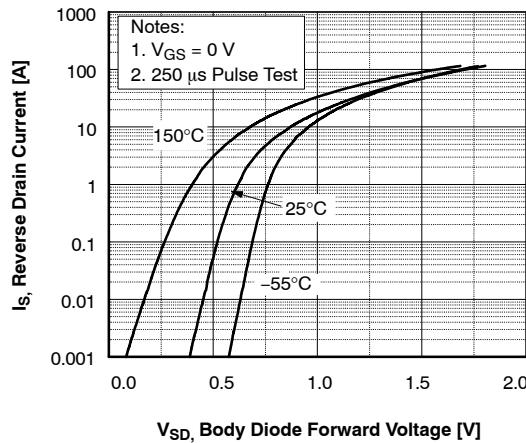
**Figure 1. On-Region Characteristics**



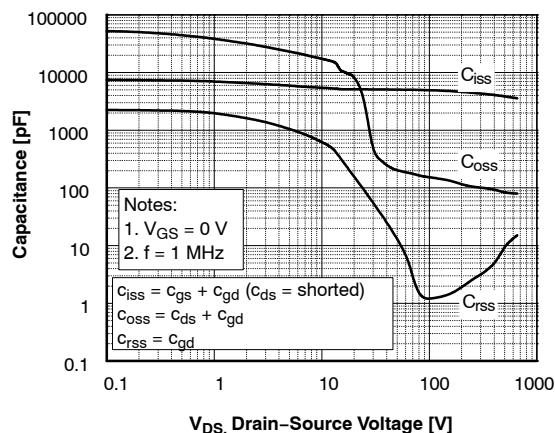
**Figure 2. Transfer Characteristics**



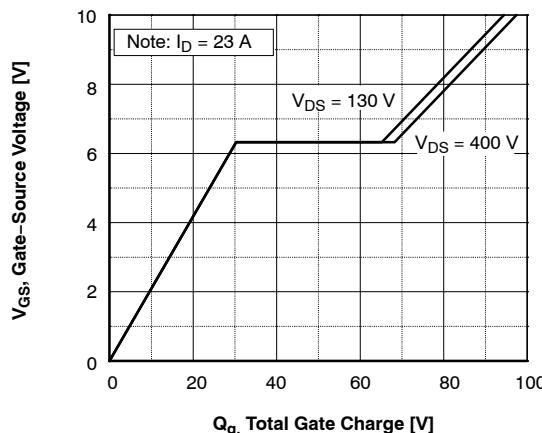
**Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage**



**Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature**

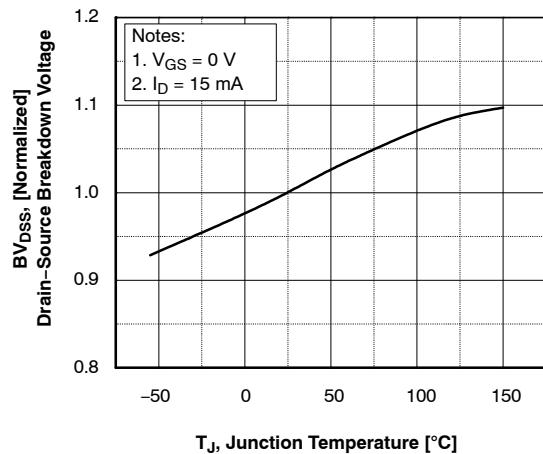


**Figure 5. Capacitance Characteristics**

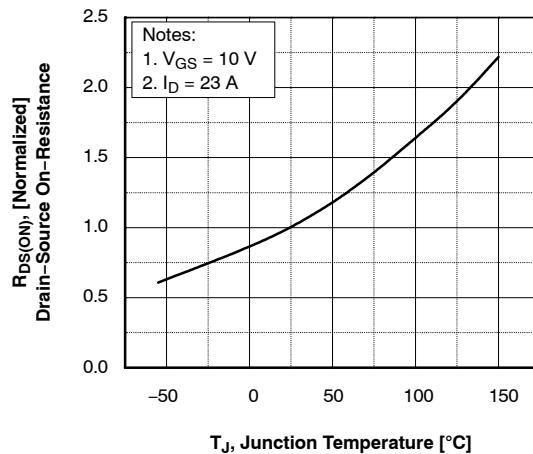


**Figure 6. Gate Charge Characteristics**

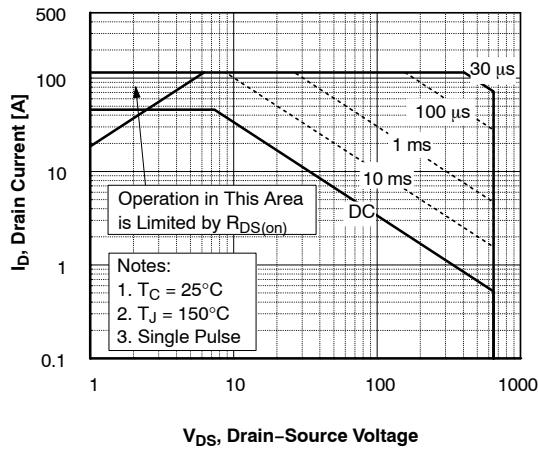
**TYPICAL PERFORMANCE CHARACTERISTICS (Continued)**



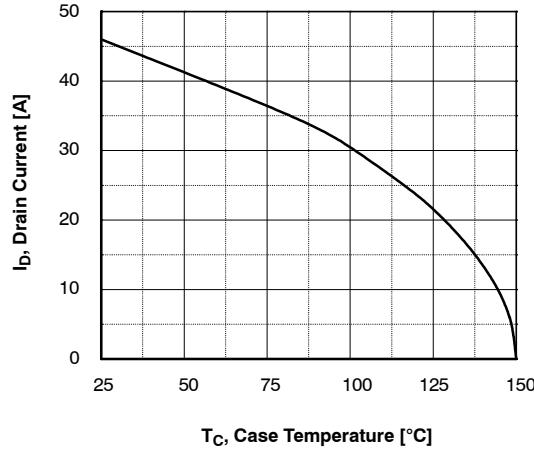
**Figure 7. Breakdown Voltage Variation vs. Temperature**



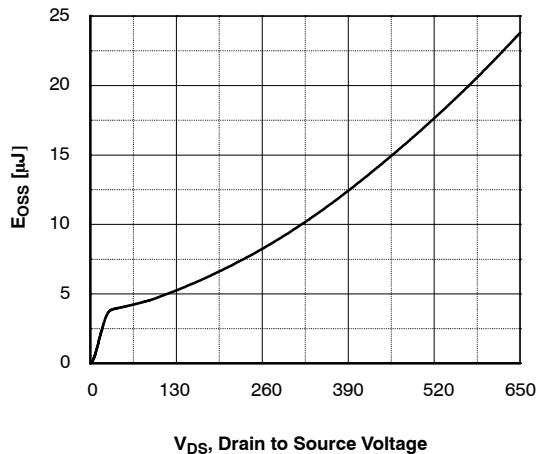
**Figure 8. On-Resistance Variation vs. Temperature**



**Figure 9. Maximum Safe Operating Area**



**Figure 10. Maximum Drain Current vs. Case Temperature**



**Figure 11.  $E_{oss}$  vs. Drain to Source Voltage**

## TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

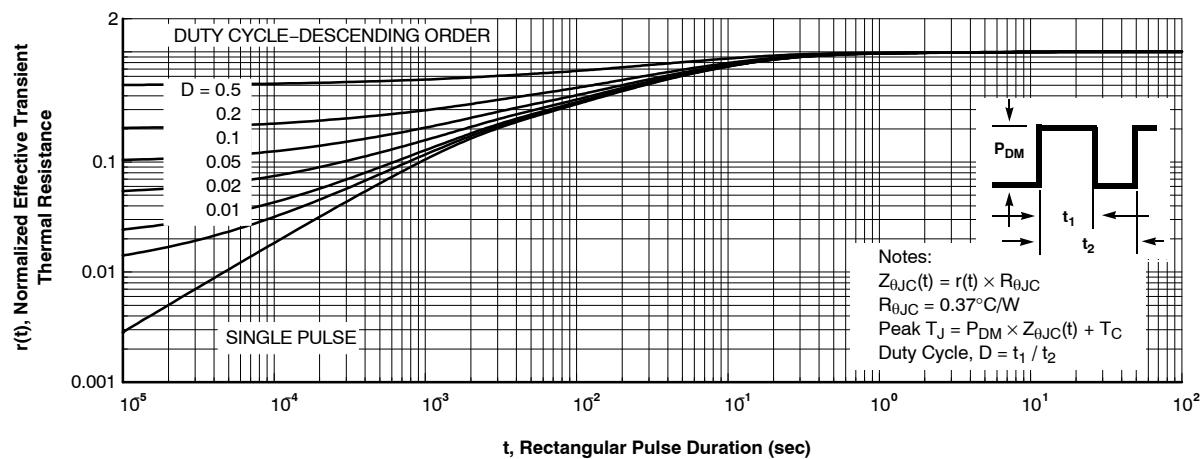
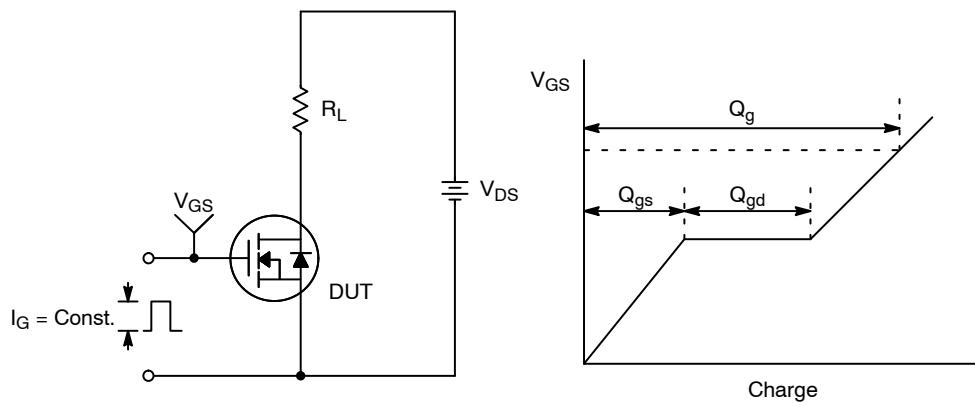
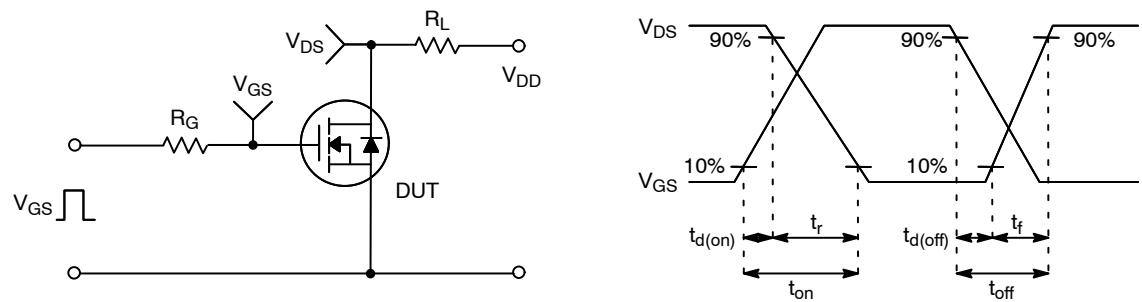


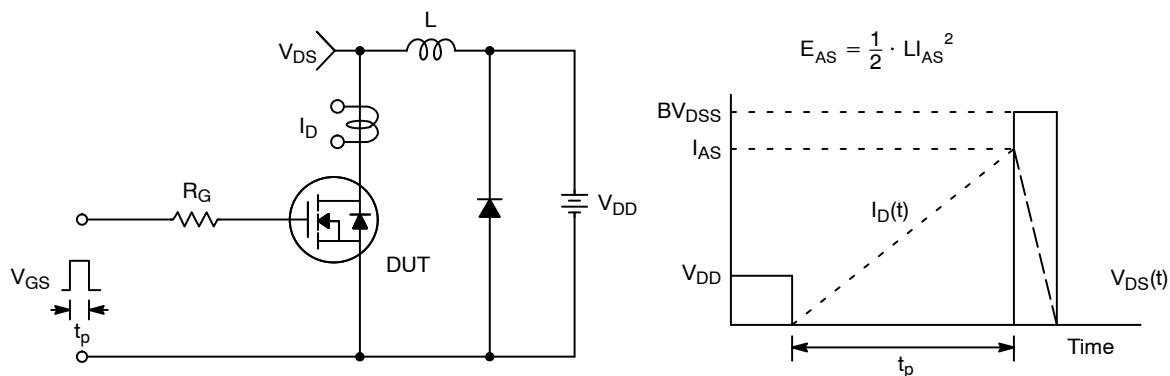
Figure 12. Transient Thermal Response Curve



**Figure 13. Gate Charge Test Circuit & Waveform**



**Figure 14. Resistive Switching Test Circuit & Waveforms**



**Figure 15. Unclamped Inductive Switching Test Circuit & Waveforms**

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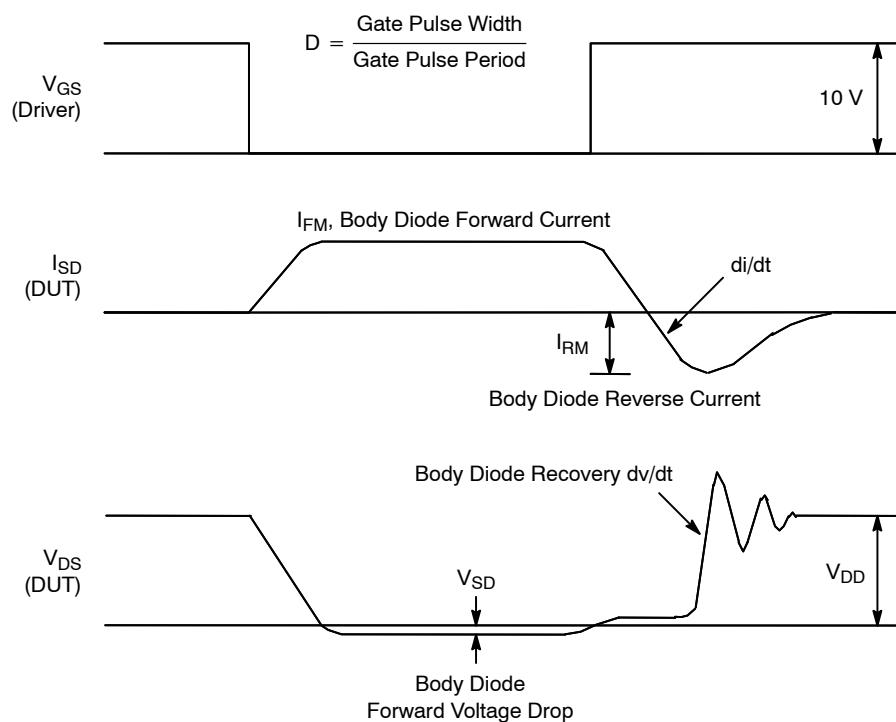
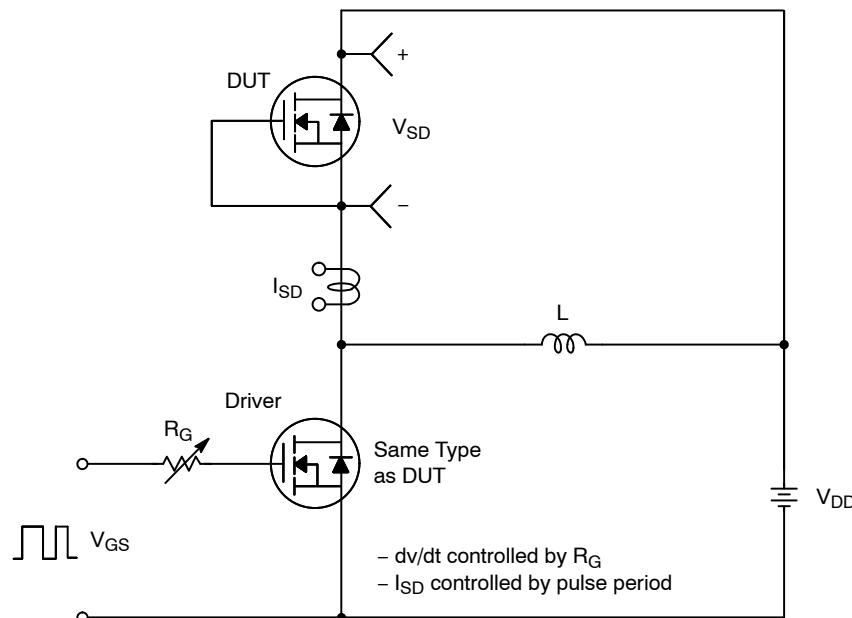


Figure 16. Peak Diode Recovery  $dv/dt$  Test Circuit & Waveforms

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